



Specification for Approval

Date: 2013/06/14

	Custom	ner:				
	TAI-TECH P/N:	DFP252012NF-SERIES				
	CUSTOMER P/N:					
	DESCRIPTION:					
	QUANTITY:	pcs				
REM	IARK:					
	Cı	istomer Approval Feedback				
西北臺慶科技股份有限公司 TAI-TECH Advanced Electronics Co., Ltd						

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Power Inductor

DFP252012NF-SERIES

	ECN HISTORY LIST						
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN		
1.0	13/06/14	新 發 行	楊祥忠	詹偉特	林宜蕰		
備							
註							

Power Inductor

DFPUHP252012NF-SERIES

1. Features

- 1. This specification applies Low Profile Power Inductors.
- 2. 100% Lead(Pb) & Halogen-Free and RoHS compliant.

2. Dimension





+	В	+
A		
		D E D
	c T	
	С Т	

Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)
DFP252012NF	2.5 -0.1/+0.3	2.0 -0.05/+0.35	1.2 max.	0.85 ref.	0.80 ref.

Units: mm

3. Part Numbering



A: Series

B: Dimension

C: Lead Free Material
D: Inductance R47=0.47uH
E: Inductance Tolerance M=±20%

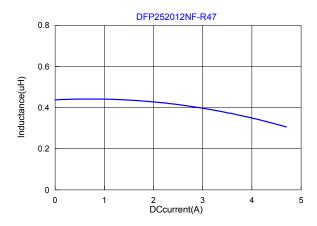
4. Specification

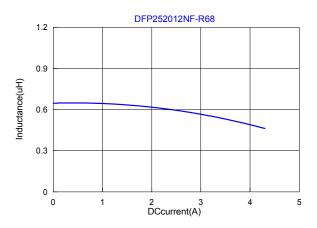
TAI-TECH Part Number	Inductance (uH)	Tolerance (%)	Test Frequency (Hz)	DCR (Ω) typ.	DCR (Ω) Max.	I sat (A) typ.	I sat (A) Max.	I rms (A) typ	I rms (A) Max.
DFP252012NF-R47M	0.47	±20%	0.1V/1M	0.029	0.039	4.70	3.80	3.90	3.30
DFP252012NF-R68M	0.68	±20%	0.1V/1M	0.042	0.055	4.40	3.70	3.50	2.90
DFP252012NF-1R0M	1.0	±20%	0.1V/1M	0.047	0.062	3.80	3.00	3.00	2.70

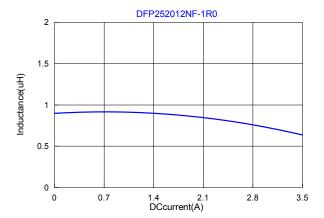
Note:

Isat : Based on inductance change $~(\,\triangle\text{L/L0}:\,\leq\text{-30\%}\,)$ @ ambient temp. $25^{\circ}\!\text{C}$

 $Irms: Based \ on \ temperature \ rise \quad (\ \triangle T: 40^\circ\!\!\!\!C.)$

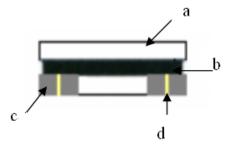


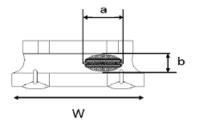




5. Material List

No.	Description	Specification				
a.	Core	Ferrite Core				
b.	Coating	Epoxy with magnetic powder				
С	Termination	Tin Pb Free				
d	Wire	Enameled Copper Wire				





Exposed wire tolerance limit of coating resin part on product side.

Size of exposed wire occurring to coating resin is specified below.

- 1. Width direction (dimension a): Acceptable when a \leq w/2 Nonconforming when a > w/2
- 2. Length direction (dimension b): Dimension b is not specified.
- 3. The total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, and is acceptable.

6. Reliability and Test Condition

Item	Performance	Test Condition
Operating Temperature	-40~+85°ℂ (For products in unopened tape package, less than 40°ℂ)	
Electrical Performance	Test	
Inductance L		Agilent-4291, Agilent-4287
Q		Agilent-4192, Agilent-4285
SRF	Refer to standard electrical characteristic list	Agilent-4291
DC Resistance		Agilent-4338
Rated Current	Base on temp. rise & △L/L0A≦30%.	Saturation DC Current (Isat) will cause L0 to drop approximately \triangle L(%).
Temperature Rise Test	ΔT 40℃Max	Heat Rated Current (Irms) will cause the coil temperature rise approximately △T(°C) without core loss. 1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer
Mechanical Performanc	e Test	
Resistance to Soldering Heat MIL-STD-202 METHOD 210	Inductors shall be no evidence of electrical and mechanical damage. Inductance: within ±10% of initial value	Temp.: 260±5°C Time: 10±1.0 Sec
Solderability Test ANSI/J-STD-002	More than 95% of terminal electrode should be covered with solder.	Preheating Dipping Natural cooling 235 C 150 C 60
Reliability Test		
Humidity Test MIL-STD-202 METHOD 103	1.Visual examination: No mechanical damage 2.Inductance: within±10% of initial value	1.Temperature: 40±2°C 2.Humidity: 90 ~ 95% 3.Time: 500 ±8hrs 4.Measured at room temperature after placing for 2 to 3 hrs
Thermal Shock Test MIL-STD-202 METHOD 107	1.Visual examination : No mechanical damage	Conditions for 1 cycle Step Temperature(°C) Times(min.) 1
High Temperature Life Test MIL-STD-202 METHOD 108	2.Inductance : within±10% of initial value	1.Temperature: 85±2℃ 2.Time: 500±8hrs 3.Measured at room temperature after placing for 2to3 hrs
Humidity Resistance Test MIL-STD-202 METHOD 103		1.Temperature:40±2°C 2.Humidity:90~95% 3.Time:500±8hr. 4.Recovery:2 to 3hrs of recovery under the standard condition after the removal from test chamber.
Low temperature Storage Test JESD22-A119		1.Temperature: -40±2°C 2.Time: 500±8hrs 3.Measured at room temperature after placing for 2to3 hrs

Item	Performance	Test Condition
		Frequency: 10-55-10Hz for 15 min.
		Amplitude: 1.52mm
Random Vibration Test	Appearance: Cracking, shipping and any other defects harmful to the	Directions and times:
MIL-STD-202	characteristics should not be allowed.	X, Y, Z directions for 15 min.
Method 204	Impedance: within±30%	This cycle shall be performed 12 times in each
metriod 204		of three mutually perpendicular directions (Total 9hours).

7. Soldering and Mounting

7-1. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

7-1.1 Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

7-1.2 Soldering Iron(Figure 2):

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- \bullet Preheat circuit and products to 150 $\!\!\!\!\!\!\!^{\circ}_{\circ}$
- $\boldsymbol{\cdot}$ Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm

- 355°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5 sec.

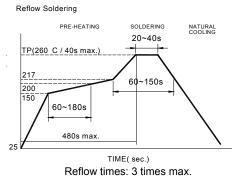


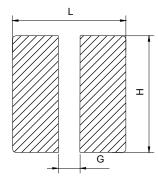
Fig.1

Iron Soldering PRE-HEATING SOLDERING NATURAL COOLING within 4~5s ပ TEMPERATURE(Over 60s Gradual cooling

Iron Soldering times: 1 times max.

Fig.2

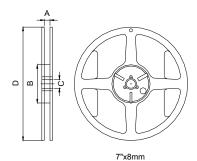
7-2. Recommended PC Board Pattern



L(mm)	G(mm)	H(mm)
2.9	0.8	2.4

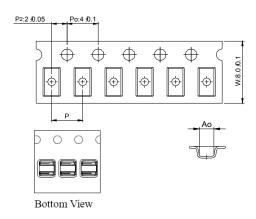
8. Packaging Information

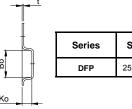
8-1. Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	8.4±1.0	50 min.	13±0.8	178±2

8-2. Tape Dimension / 8mm



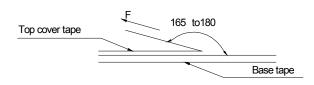


Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)
DFP	252012	3.10±0.1	2.45±0.1	1.40±0.1	4.0±0.1	0.23±0.05

8-3. Packaging Quantity

Chip size	252012	
Chip / Reel	2000	

8-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed	
(℃)	(%)	(hPa)	mm/min	
5~35	45~85	860~1060	300	

Application Notice

· Storage Conditions

To maintain the solderability of terminal electrodes:

- 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 3. Recommended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

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MLZ1608M6R8WTD25 MLZ1608N6R8LT000 MLZ1608N3R3LTD25 MLZ1608N3R3LTD00 MLZ1608N150LT000 MLZ1608N150WTD05 MLZ1608M3R3WTD25 MLZ1608M3R3WT000 MLZ1608M150WT000 MLZ1608A1R5WT000 MLZ1608N1R5LT000 B82432C1333K000 PCMB053T-1R0MS PCMB053T-1R5MS PCMB104T-1R5MS CR32NP-100KC CR32NP-151KC CR32NP-180KC CR32NP-181KC CR32NP-1R5MC CR32NP-390KC CR32NP-390KC CR32NP-389MC CR32NP-680KC CR32NP-820KC CR32NP-8R2MC CR43NP-390KC CR43NP-560KC CR43NP-680KC CR54NP-181KC CR54NP-470LC CR54NP-820KC CR54NP-8R5MC MGDQ4-00004-P MGDU1-00016-P MHL1ECTTP18NJ MHL1JCTTD12NJ PE-51506NL PE-53601NL PE-53630NL PE-53824SNLT PE-62892NL PE-92100NL PG0434.801NLT PG0936.113NLT PM06-2N7 PM06-39NJ HC2LP-R47-R HC2-R47-R HC3-2R2-R HC8-1R2-R